



H11D1/H11D2/H11D3/H11D4

Phototransistor, 5.3 KV, TRIOS®

High BV_{CER} Voltage Optocoupler

FEATURES

- CTR at $I_F=10$ mA, $BV_{CER}=10$ V: $\geq 20\%$
- Good CTR Linearity with Forward Current
- Low CTR Degradation
- Very High Collector-Emitter Breakdown Voltage
 - H11D1/H11D2, $BV_{CER}=300$ V
 - H11D3/H11D4, $BV_{CER}=200$ V
- Isolation Test Voltage: 5300 V_{RMS}
- Low Coupling Capacitance
- High Common Mode Transient Immunity
- Phototransistor Optocoupler in 6 Pin DIP Package with Base Connection
- Field Effect Stable: TRIOS*
- VDE 0884 Available with Option 1
- Underwriters Lab File #E52744

APPLICATIONS

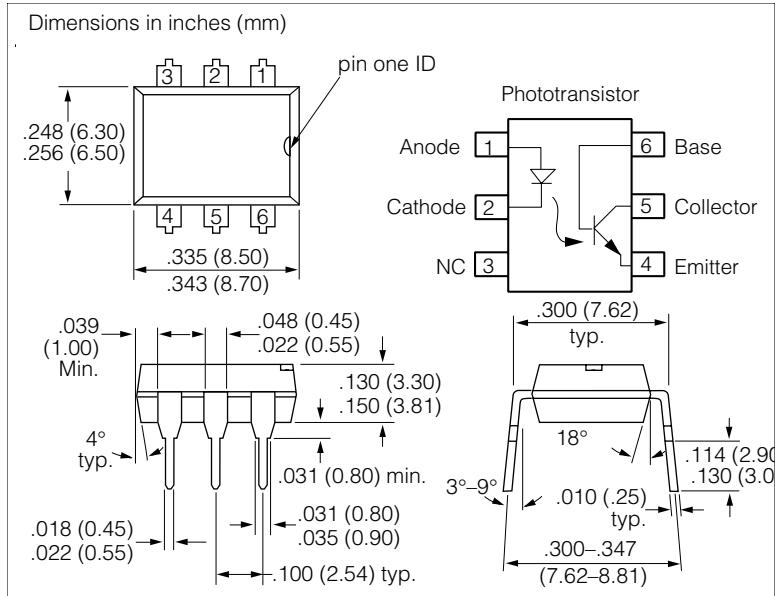
- Telecommunications
- Replace Relays

DESCRIPTION

The H11D1/2/3/4 are optocouplers with very high BV_{CER} . They are intended for telecommunications applications or any DC application requiring a high blocking voltage.

The H11D1/D2 are identical and the H11D3/D4 are identical.

*TRIOS—TRansparent IOn Shield



Maximum Ratings $T_A=25^\circ\text{C}$

Emitter

| | |
|--|--------|
| Reverse Voltage..... | 6.0 V |
| DC Forward Current..... | 60 mA |
| Surge Forward Current ($t \leq 10 \mu\text{s}$)..... | 2.5 A |
| Total Power Dissipation..... | 100 mW |

Detector

| | |
|---------------------------|-------|
| Collector-Emitter Voltage | |
| H11D1/2 | 300 V |
| H11D3 /4 | 200 V |

Collector-Base Voltage

| | |
|----------------|-------|
| H11D1/2 | 300 V |
| H11D3 /4 | 200 V |

Emitter-Base Voltage.....

Collector Current.....

Total Power Dissipation.....

Package

| | |
|---|-----------------------|
| Isolation Test Voltage (between emitter and detector, refer to climate DIN 50014, part 2, Nov. 74) | 5300 V _{RMS} |
| Insulation Thickness between Emitter and Detector | ≥ 0.4 mm |
| Creepage Distance..... | ≥ 7.0 mm |
| Clearance Distance | ≥ 7.0 mm |
| Comparative Tracking Index (per DIN IEC 112/VDE 0303, part 1) | 175 |

| | |
|---|-----------------------|
| Isolation Resistance | |
| $V_{IO}=500$ V, $T_A=25^\circ\text{C}$ | $\geq 10^{12} \Omega$ |
| $V_{IO}=500$ V, $T_A=100^\circ\text{C}$ | $\geq 10^{11} \Omega$ |

Storage Temperature Range.....

Operating Temperature Range.....

Junction Temperature

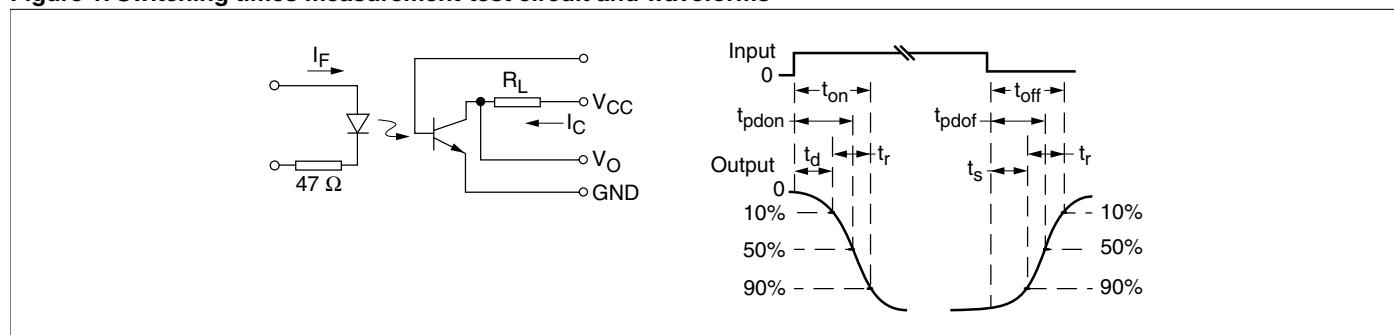
Soldering Temperature (max. 10 sec., dip soldering: distance to seating plane ≥ 1.5 mm)

260°C

Characteristics $T_A=25^\circ\text{C}$, unless otherwise specified)

| Parameter | Symbol | Min | Typ | Max | Unit | Condition |
|---------------------------------------|-------------------|--------------------|------|------|---------------|---|
| Emitter | | | | | | |
| Forward Voltage | V_F | — | 1.1 | 1.5 | V | $I_F=10 \text{ mA}$ |
| Reverse Voltage | V_R | 6.0 | — | — | | $I_R=10 \mu\text{A}$ |
| Reverse Current | I_R | — | 0.01 | 10 | μA | $V_R=6.0 \text{ V}$ |
| Capacitance | C_O | — | 25 | — | pF | $V_R=0 \text{ V}, f=1.0 \text{ MHz}$ |
| Thermal Resistance | R_{thJA} | — | 750 | — | K/W | — |
| Detector | | | | | | |
| Voltage, Collector-Emitter | H11D1/H11D2 | BV_{CER} | 300 | — | — | $I_{CE}=1.0 \text{ mA}, R_{BE}=1.0 \text{ M}\Omega$ |
| | H11D3/H11D4 | | 200 | — | — | — |
| Voltage, Emitter-Base | | BV_{EBO} | 7.0 | — | — | $I_{EB}=100 \mu\text{A}$ |
| Capacitance | | C_{CE} | — | 7.0 | — | $V_{CE}=10 \text{ V}, f=1.0 \text{ MHz}$ |
| | | C_{CB} | — | 8.0 | — | $V_{CB}=10 \text{ V}, f=1.0 \text{ MHz}$ |
| | | C_{EB} | — | 38 | — | $V_{EB}=5.0 \text{ V}, f=1.0 \text{ MHz}$ |
| Thermal Resistance | | R_{thJA} | — | 250 | — | K/W |
| Package | | | | | | |
| Coupling Capacitance | | C_C | — | 0.6 | — | pF |
| Coupling Transfer Ratio | | I_C/I_F | 20 | — | — | % |
| Collector-Emitter, Saturation Voltage | | $V_{CE\text{sat}}$ | — | 0.25 | 0.4 | V |
| Leakage Current, Collector-Emitter | H11D1/H11D2 | I_{CER} | — | — | 100 | nA |
| | H11D3/H11D4 | | — | — | — | $V_{CE}=100 \text{ V}, R_{BE}=1.0 \text{ M}\Omega$ |
| | H11D1/H11D2 | | — | — | 250 | μA |
| | H11D3/H11D4 | | — | — | — | $V_{CE}=100 \text{ V}, R_{BE}=1.0 \text{ M}\Omega, T_A=100^\circ\text{C}$ |

Figure 1. Switching times measurement-test circuit and waveforms



Switching Times (typ.)

$I_C=2.0 \text{ mA}$ (to be adjusted by varying I_F), $R_L=100\Omega$,
 $T_A=25^\circ\text{C}$, $V_{CC}=10 \text{ V}$

| Description | Symbol | Values | Unit |
|---------------|-----------|--------|---------------|
| Turn-On Time | t_{ON} | 5.0 | μs |
| Rise Time | t_r | 2.5 | |
| Turn-Off Time | t_{OFF} | 6.0 | |
| Fall Time | t_f | 5.5 | |

Figure 2. Current transfer ratio (typ.) $V_{CE}=10$ V, $T_A=25^\circ\text{C}$, normalized to $I_F=10$ mA, NCTR=f(I_F)

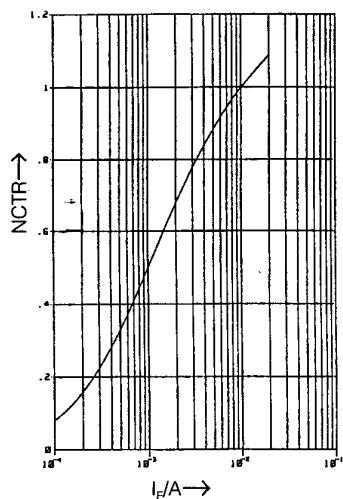


Figure 3. Diode forward voltage (typ.) $V_F=f(I_F, T_A)$

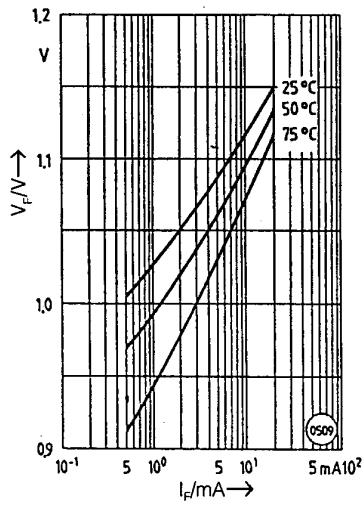


Figure 4. Output characteristics (typ.) $T_A=25^\circ\text{C}$, $I_{CE}=f(V_{CE}, I_B)$

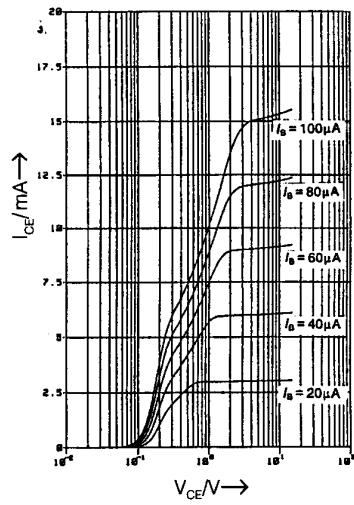


Figure 5. Output characteristics (typ.) $T_A=25^\circ\text{C}$, $I_{CE}=f(V_{CE}, I_F)$

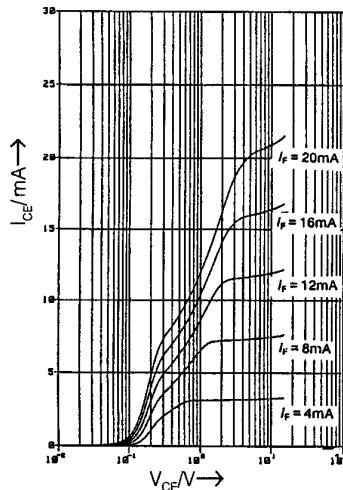


Figure 6. Transistor capacitances (typ.) $T_A=25^\circ\text{C}$, $f=1.0$ MHz, $C_{CE}=f(V_{CE})$
 $C_{CB}=f(V_{CB})$, $C_{EB}=f(V_{EB})$

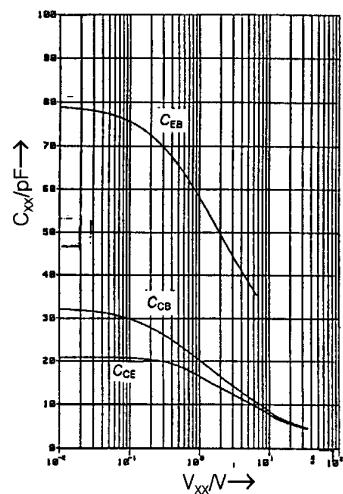


Figure 7. Collector-emitter leakage current (typ.) $I_F=0$, $R_{BE}=1.0$ MΩ, $I_{CER}=f(V_{CE})$

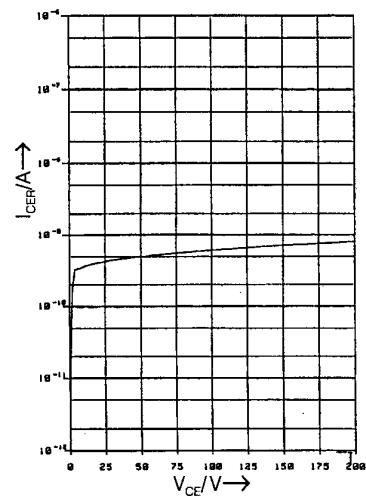


Figure 8. Permissible loss diode
 $I_F=f(T_A)$

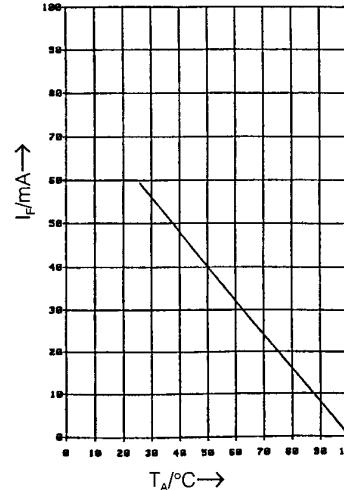


Figure 9. Permissible power dissipation
 $P_{tot}=f(T_A)$

